



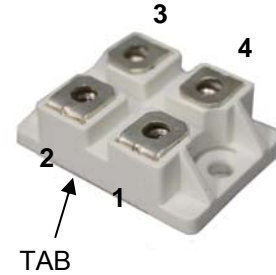
Name: AnSP75FRD12, AnSA75FRD12

Applications

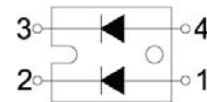
- Antiparallel diode for switching devices
- Free wheeling diode in converters and motor control circuits
- Inductive heating
- UPS

Features

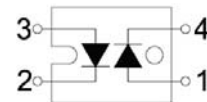
- Low switching losses
- Soft, fast switching
- Planar passivated chip
- Cooler operation
- Max. operating junction temperature 150 °C



AnSP75FRD12



AnSA75FRD12



Product Summary

| Part Number | V _{RR} | V _F | I _F | Packaging |
|-------------|-----------------|----------------|----------------|-----------|
| AnSP75FRD12 | 1200 V | 2.5 V | 2 × 75 A | Box |
| AnSA75FRD12 | | | | |

Table 1. Absolute Maximum Ratings

| | Parameter | Value | Units |
|-----------------------------------------|---------------------------------------------------|--------------|-------|
| V _R | D.C. Reverse voltage | 1200 | V |
| V _{RRM} | Repetitive Reverse voltage | | |
| I _F , T _C =25 °C | Forward Current | 2 × 75 | A |
| I _{FM} , T _C =25 °C | Pulsed Forward Current | 2 × 150 | |
| P _{tot} | Power dissipation T _C =25 °C per diode | 175 | W |
| T _j | Operating Temperature | -55 to +150 | °C |
| T _{stg} | Storage Temperature | -55 to +125 | |
| T _L | Lead Temperature for 10 sec | 300 | |
| | Weight | 30 (Typical) | |
| V _{is} | Insulation Test Voltage t=1 min | 2500 | Vrms |
| | Mounting Torque | 1.1 | N * m |

**Table 2. Thermal resistance**

| Symbol | Parameter | Min | Max | Units | Test Conditions |
|-------------------|-----------------------------|-----|------|-------|-----------------|
| R _{thJc} | Junction-to-Case, per diode | – | 0.64 | °C/W | |
| R _{thJA} | Junction-to-Ambient | – | 40 | | |

Table 3. Electrical Characteristics @ T_J=25°C

| Symbol | Parameter | Min. | Typ. | Max. | Units | Test Conditions |
|-----------------|-------------------------|------|------|------|-------|------------------------------------------------|
| V _F | Forward Voltage | – | 1.9 | 2.5 | V | I _F =75 A |
| | | – | 2.1 | 3.0 | | I _F =75 A, T _J =125 °C |
| I _{RR} | Reverse Leakage Current | – | 0.01 | 0.25 | mA | V _R =1200 V |
| | | – | 0.8 | 5.0 | | V _R =1200 V, T _J =125 °C |

Table 4. Recovery Characteristics

| Symbol | Parameter | Min. | Typ. | Max. | Units | Test Conditions |
|------------------|----------------------------------|------|------|------|-------|---------------------------------------------------------------------------------|
| I _{rrm} | Maximum Reverse Recovery Current | – | 45 | – | A | I _F =75 A, di _F /dt=0.4 A/ns, T _J =25 °C |
| t _{rr} | Diode Reverse Recovery Time | – | 180 | 300 | ns | |
| Q _{rr} | Diode Reverse Recovery Charge | – | 4.0 | – | µC | |

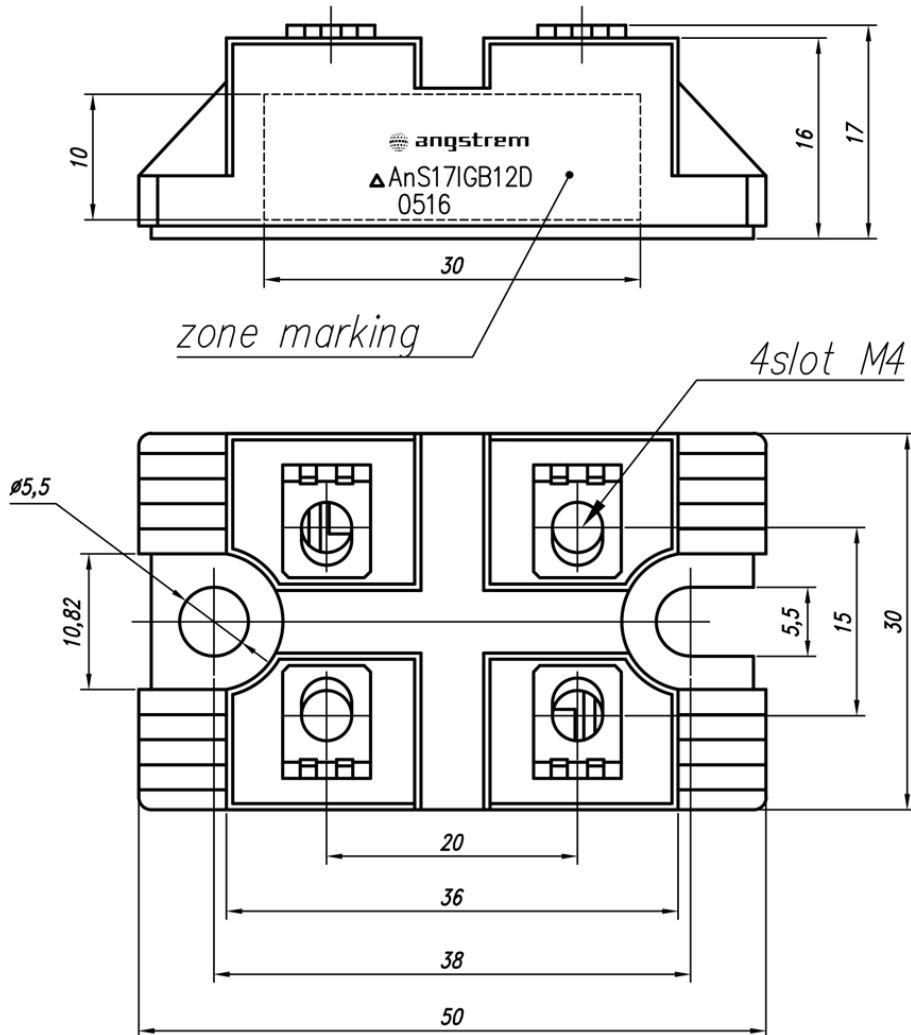
Precious metal content into 1000 pieces:

Gold _____ g;

Silver _____ g.

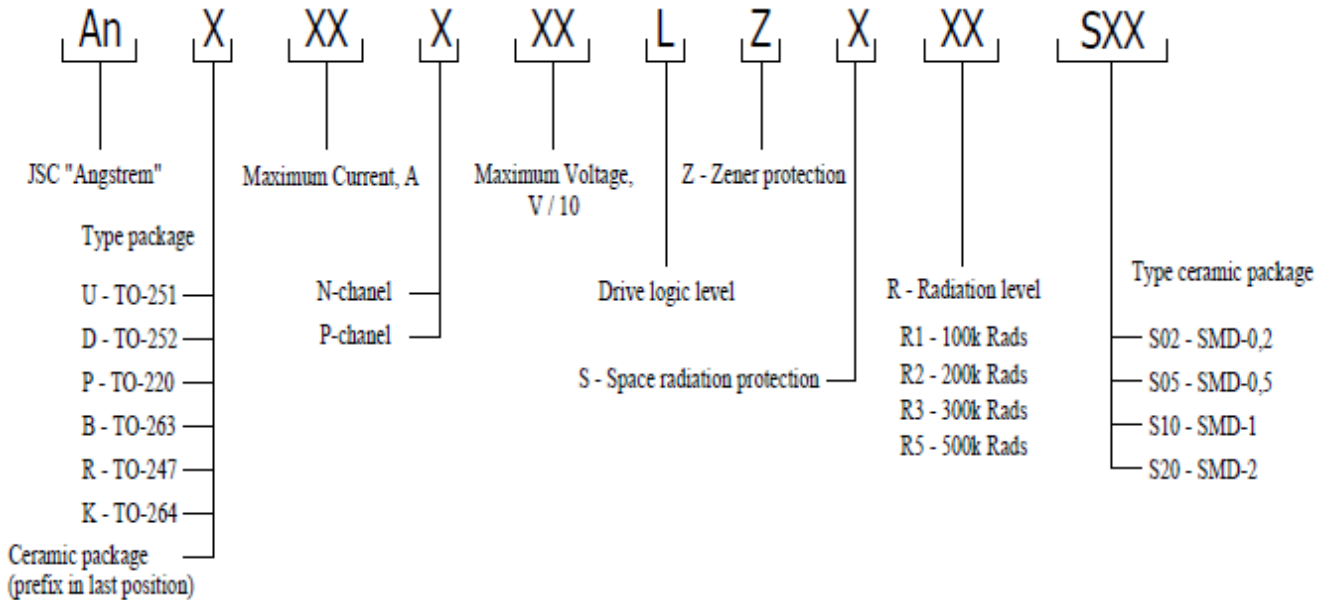


Case Outline and Dimensions - SOT-227 miniBlock

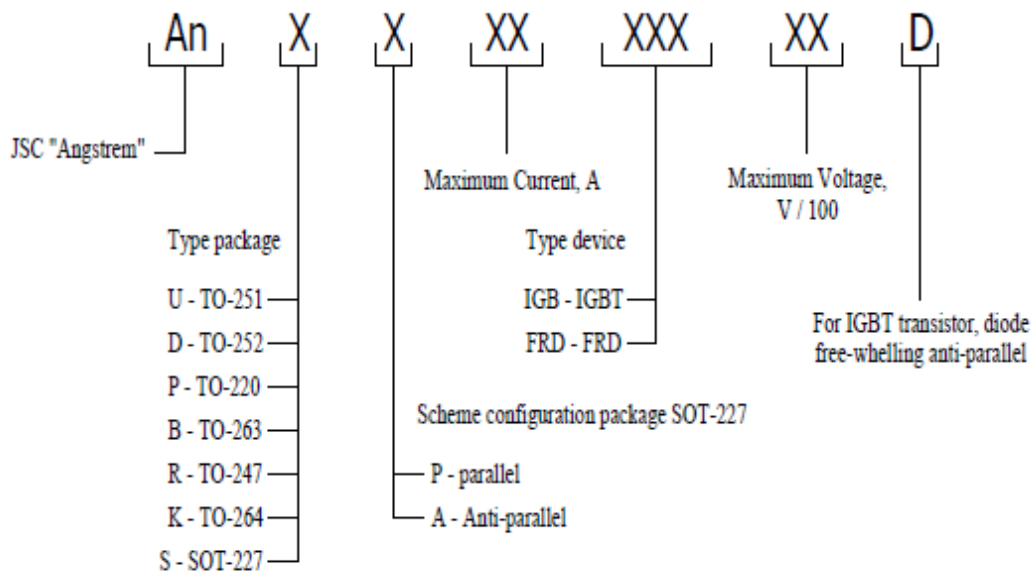




Description name MOSFET



Description name IGBT & FRD



- Sample:
- AnB7N60 - MOSFET N-channel, 7A, 600V, package TO-263
 - An10N70R1S10 - MOSFET N-channel, 10A, 700V, Radiation level 100k Rads, package SMD-1
 - AnR75IGB12 - IGBT, 75A, 1200V, package TO-247
 - An50FRD17 - FRD, 50A, 1700V, chip
 - AnSP100FRD04 - FRD, 200A, 400V, package SOT-227 configuration two diode parallel